

# 2024 The 9th International Conference on Integrated Circuits and Microsystems

October 25-27, 2024 | Wuhan, China

[www.icicm.net](http://www.icicm.net)

# 9<sup>th</sup> ICICM2024

2024 The 9th International Conference on Integrated Circuits and Microsystems (ICICM 2024) will be held in Wuhan, China on October 25-27, 2024, which is co-sponsored by Southeast University, China; University of Electronic Science and Technology of China, and Wuhan University of Technology, China.

## Invited Speakers Recruitment

- ICICM 2024 recruit domestic and international invited speakers in the Integrated Circuits and Microsystems field.
- ICICM 2024 will assign the selected presentations to relevant forums. Applicants are requested to send their resumes, academic achievements, speech title and abstract, and two-inch photo as attachments to [icicm\\_conf@vip.163.com](mailto:icicm_conf@vip.163.com).
- Invited speakers are required to share best practices and research results, and are not allowed to promote any products or services during the speech.

## Topics

Include but not limited

- Devices and Circuits for Wireless System
- Application Specific Circuits and Systems for Communication
- Digital, Analog, Mixed Signal IC and SOC design technology
- Silicon integrated circuits and manufacturing
- Low-power, RF devices & circuits
- IC Computer-Aided –Design technology, DFM
- Silicon/germanium devices and device physics
- Interconnect, Low K, High K and other process technologies
- Unconventional and nano-electronics
- Organic semiconductor devices and technologies
- Compound semiconductor devices and circuits
- Displays, sensors and MEMS
- Semiconductor materials and material characterization
- Packaging and testing technology
- Solar cell & other devices for new energy sources
- Modeling and simulation
- Equipment technology
- Displays, sensors and MEMS
- Advance memories technology

For more topics, please visit at: <http://icicm.net/call-for-papers.html>

### Track Recruitment

If you are willing to organise one or more tracks, please contact us to get more details. All papers in track will also be included in the conference proceedings and indexed by EI Compendex and Scopus.

## Submission

- Full paper (Presentation & Publication)
- Abstract (Presentation only)

Submission Link:

<https://easychair.org/conferences/?conf=icicm2024>

Email submission: [icicm\\_conf@vip.163.com](mailto:icicm_conf@vip.163.com)

Full paper template (Word): <http://icicm.net/files/Template.doc>

Full paper template (Latex):

<http://icicm.net/files/IEEE-conference-proceeding-Latex.rar>

## Publication

Submitted papers will be Peer-Reviewed (Double Blind) and the accepted ones will be collected in the conference proceedings and indexed by EI Compendex and Scopus, etc.

\*\*Proceedings of ICICM2016-2022 have been successfully include in IEEE Xplore and indexed by EI Compendex and Scopus already!

## Conference History

|           |          |                         |
|-----------|----------|-------------------------|
| ICICM2016 | Chengdu  | ISBN: 978-1-5090-2814-6 |
| ICICM2017 | Nanjing  | ISBN: 978-1-5386-3506-3 |
| ICICM2018 | Shanghai | ISBN: 978-1-5386-8311-8 |
| ICICM2019 | Beijing  | ISBN: 978-1-7281-5132-8 |
| ICICM2020 | Nanjing  | ISBN: 978-1-7281-8978-9 |
| ICICM2021 | Nanjing  | ISBN: 978-1-6654-5886-3 |
| ICICM2022 | Xi'an    | ISBN: 978-1-6654-6042-2 |
| ICICM2023 | Nanjing  | ISBN: 979-8-3503-1849-4 |

## Organizing Committee

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Thanayaburi, Thailand  
Wei Ren, Xi'an University of Posts and Telecommunications, China

## Important Dates

| Submission Deadline | Notification Deadline | Registration Deadline |
|---------------------|-----------------------|-----------------------|
| April 30, 2024      | May 30, 2024          | June 20, 2024         |

Co-Sponsored by:



Hosted by:



Patrons:



Conference Secretary: Ms. Jenny Chow

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Contact Us